

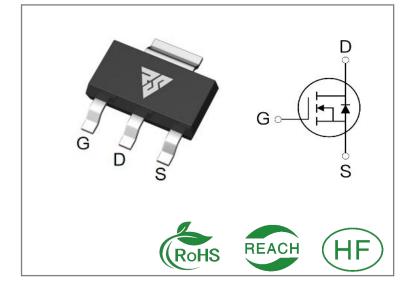
ID	R <sub>DS</sub> (ON)(Typ)	VDSS
2A	3.5Ω	600V

## **Applications:**

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

#### **Features:**

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



### **Ordering Information**

Part Number	Package	Marking	Packing	Qty.
RS2N60C	SOT-223	RS2N60C	Tape&reel	4000 PCS

### Absolute Maximun Ratings Tc= 25 ℃ unless otherwise specified

Symbol	Parameter	RS2N60C	Units
VDSS	Drain-to-Source Voltage	600	V
ID	Continuous Drain Current	2	
IDM	Pulsed Drain Current (Note*1)	8	A
PD	Power Dissipation	28	W
VGS	Gate- to- Source Voltage	±30	V
EAS	Single Pulse Avalanche Engergy L = 10.0mH, VDD = 50V, RG = 25 $\Omega$	28.8	mJ
IAS	Avalanche Current (Note*1)	2.4	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note*1)	0.12	mJ
	Maximum Temperature for Soldering	300	
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds		$^{\circ}$ C
TJ and	Operating Junction and Storage	-55 to 150	
TSTG	Temperature Range	-33 (0.130	

<sup>\*</sup> Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



### **Thermal Resistance**

Symbol	Parameter	RS2N60C	Units	Test Conditions
RθJC	Junction-to-Case	4.53	°C/ <b>W</b>	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^{\circ}$ C
RθJA	Junction-to- Ambient	60		1 cubic foot chamber,free air.

## **OFF Characteristics** TJ= 25<sup>°</sup>C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	600			V	VGS=0V,ID=250μA
IDSS	Drain- to- Source Leakage Current			1	μΑ	VDS=600V,VGS=0 V
	Gate- to- Source Forward Leakage			100		VGS=30V,VDS=0V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-30V ,VDS=0 V

## ON Characteristics TJ=25 °C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance(Note*2)		3.5	4.2	Ω	VGS=10V,ID=1A
VGS(TH)	Gate Threshold Voltage	3		4	٧	VGS=VDS,ID=250μ A

## Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		33.6			
trise	Rise Time		7.2			VDS=300V ID=2A
td(OFF)	Turn- OFF Delay Time		64		nS	RG=25Ω
tfall	Fall Time		31.2			



## **Dynamic Characteristics** Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		248.5			VGS=0V
Coss	Output Capacitance		30		pF	VDS=25V
Crss	Reverse Transfer Capacitance		4.2			f=1.0MHz
Qg	Total Gate Charge		11			
Qgs	Gate- to- Source Charge		1.55		nC	VDS=480V ID=2A VGS=10V
Qgd	Gate-to-Drain(" Miller") Charge		6.15			

### **Source-Drain Diode Characteristics**

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			2	Α	Integral pn- diode
ISM	Maximum Pulsed Current			8	Α	in MOSFET
VSD	Diode Forward Voltage			1.4	٧	IS=1A,VGS=0V
trr	Reverse Recovery Time		490		nS	VGS=0V
Qrr	Reverse Recovery Charge		0.6		μС	IS=2A,di/dt=100A/ μs

## Notes:

<sup>\* 1.</sup> Repetitive rating, pulse width limited by maximum junction temperature.

<sup>\* 2.</sup> Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1%



#### **Typical Feature Curve**

Figure 1. Output Characteristics (T, = 25°C)

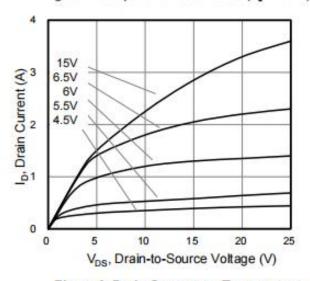


Figure 3. Drain Current vs. Temperature

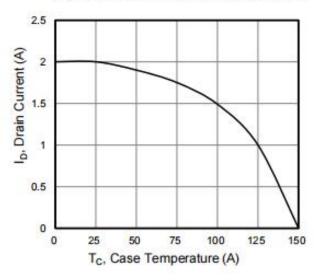


Figure 5. Transfer Characteristics

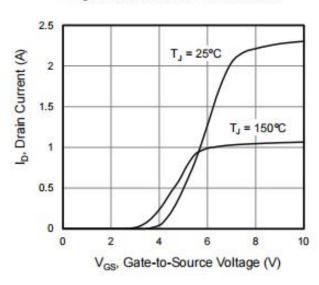


Figure 2. Body Diode Forward Voltage

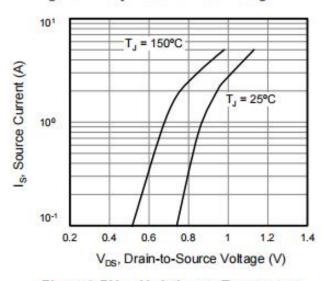


Figure 4. BV<sub>DSS</sub> Variation vs. Temperature

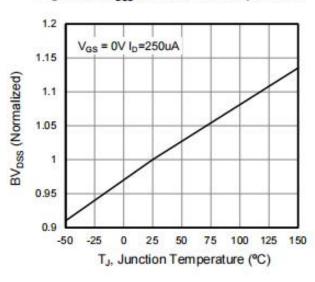


Figure 6. On-Resistance vs. Temperature

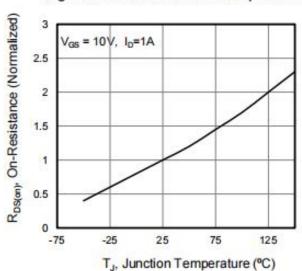


Figure 7. Capacitance

103

Ciss

Coss

104

Coss

Coss

VGS = 0V

f = 1MHz

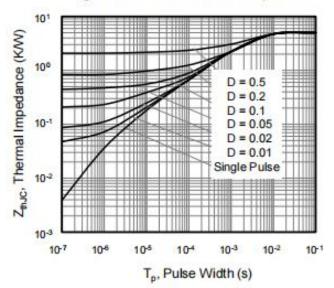
0 10 20 30 40

V<sub>DD</sub> = 480V V<sub>DD</sub> = 300V V<sub>DD</sub> = 120V V<sub>DD</sub> = 120V Q<sub>g</sub>, Total Gate Charge (nC)

Figure 8. Gate Charge

Figure 9. Transient Thermal Impedance

V<sub>DS</sub>, Drain-to-Source Voltage (V)





### **Test Circuits and Waveforms**

Figure A: Gate Charge Test Circuit and Waveform

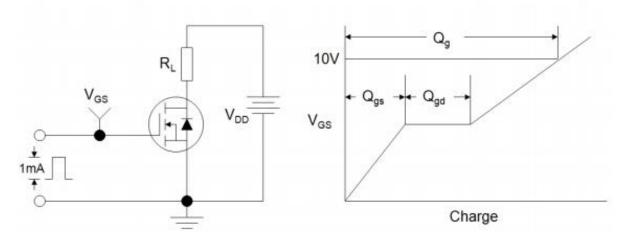


Figure B: Resistive Switching Test Circuit and Waveform

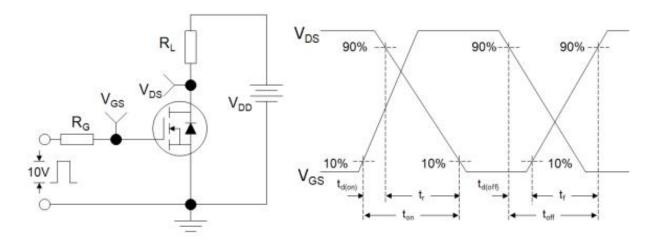
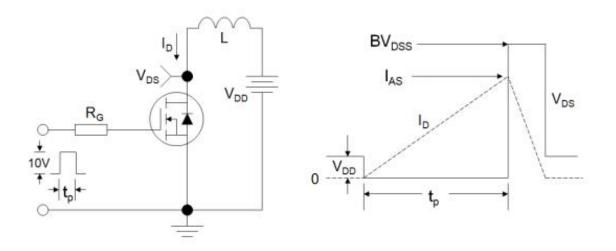


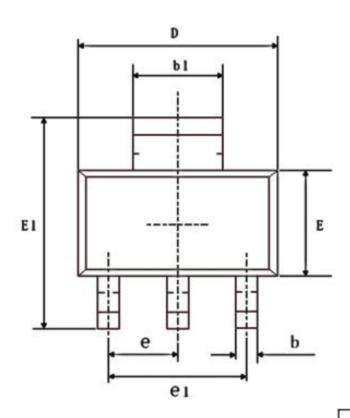
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

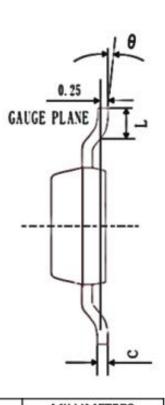


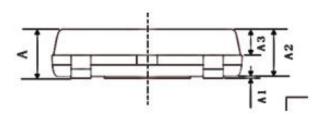


## Package outline drawing

# SOT-223







SYMBOLS	MILLIMETERS				
STIVIBULS	MIN	MAX			
Α		1.80			
A1	0.00	0.10			
A2	1.50	1.70			
A3	0.85	0.95			
b	0.66	0.80			
b1	2.96	3.10			
С	0.25	0.35			
D	6.30	6.70			
E	3.30	3.70			
E1	6.80	7.20			
e1	4.40	4.80			
L	0.90	1.15			
Θ	0.00	10.00			
е	2.3BSC				



#### **Disclaimers:**

Reasunos Semiconductor Technology Co.Ltd (Reasunos) reserves the right to make changes without notice in order to improve reliability, function or design and to discontinue any product or service without notice. Customers should obtain the latest relevant information before orders and should verify that such information in current and complete. All products are sold subject to Reasunos's terms and conditions supplied at the time of orderacknowledgement.

Reasunos Semiconductor Technology Co.Ltd warrants performance of its hardware products to the speciffications at the time of sale. Testing, reliability and quality control are used to the extene Reasunos deems necessary to support this warrantee. Except where agreed upon by contr- actual agreement, testing of all parameters of each product is not necessarily performed.

Reasunos Semiconductor Technology Co.Ltd does not assume any liability arising from the use of any product or circuit designs described herein. Customers are responsible for their products and applications using Reasunos's components. To minimize risk, customers must provide adequate design and operating safeguards.

Reasunos Semiconductor Technology Co.Ltd does not warrant or convey any license eith- er expressed or implied under its patent rights,nor the rights of others. Reproduction of inform- ation in Reasunos's data sheets or data books is permissible only if reproduction is without modification oralteration. Reproduction of this information with any alteration is an unfair and deceptive business practice. Reasunos Semiconductor Technology Co.Ltd is not responsi- ble or liable for such altered documentation.

Resale of Reasunos's products with statements different from or beyond the parameters stated by Reasunos Semiconductor Technology Co.Ltd for that product or service voids all exp- ress or implied warrantees for the associated Reasunos's product or service and is unfair and deceptive business practice. Reasunos Semiconductor Technology Co.Ltd is not responsi- ble or liable for such statements.

#### **Life Support Policy:**

Reasunos Semiconductor Technology Co.Ltd's Products are not authorized for use as critical components in life support devices or systems without the expressed written approval of Reasunos Semiconductor Technology Co.Ltd.

#### As used herein:

- 1. Life support devices or systems are devices or systems which: a.are intended for surgical implant into the human body, b.support or sustain life,
- c.whose failuer to when properly used in accordance with instructions for used provided in the laeling, can be reasonably expected to result in significant injury to the user.
- 2.A critical component is any component of a life support device or system whose failure to system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by REASUNOS manufacturer:

Other Similar products are found below:

IRFD120 JANTX2N5237 BUK455-60A/B MIC4420CM-TR VN1206L NDP4060 SI4482DY IPS70R2K0CEAKMA1 SQD23N06-31L-GE3
TK16J60W,S1VQ(O 2SK2614(TE16L1,Q) DMN1017UCP3-7 DMN1053UCP4-7 SQJ469EP-T1-GE3 NTE2384 DMC2700UDMQ-7
DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP NTMC083NP10M5L NVMFS2D3P04M8LT1G BXP7N65D
BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR
DMNH15H110SK3-13 SLF10N65ABV2 BSO203SP BSO211P